L Number	Hits	Search Text	DB	Time stamp
2	4	(endpoint adj1 detect\$) and	USPAT;	2003/10/01
2	4	electropolishing	EPO; JPO;	10:33
		electropolishing	DERWENT;	10.33
•	}		IBM TDB	
3	578	(endpoint adj1 detect\$) and polishing	USPAT;	2003/10/01
3	] 378	(enapoint adji detect) and polishing	EPO; JPO;	10:33
			DERWENT;	10.55
			IBM TDB	
4	16559	(endpoint adj1 detect\$) and polishing or	USPAT;	2003/10/01
4	10339	planarization	EPO; JPO;	10:34
		Pianalizacion	DERWENT;	10.54
			IBM TQB	
5	5494	((endpoint adj1 detect\$) and polishing or	USPAT;	2003/10/01
3	3131	planarization) and pad	EPO; JPO;	10:34
		pianalización, ana paa	DERWENT;	10.31
			IBM TDB	
6	116	(((endpoint adj1 detect\$) and polishing	USPAT;	2003/10/01
· ·	110	or planarization) and pad) and	EPO; JPO;	10:40
		electrolyte	DERWENT;	10.10
			IBM TDB	
7	626	(endpoint adj1 detect\$) and	USPAT;	2003/10/01
•	023	(planarization or polishing)	EPO; JPO;	10:41
	:	(pranarization of porisining)	DERWENT;	1 10.11
			IBM TDB	1
8	17	((endpoint adj1 detect\$) and	USPAT;	2003/10/01
J	1	(planarization or polishing)) and	EPO; JPO;	11:07
		electrolyte	DERWENT;	11.07
		02002270	IBM TDB	
9	43309	204/\$.ccls.	USPAT	2003/10/01
				11:07
10	77	204/\$.ccls. and (endpoint adj1 detect\$)	USPAT	2003/10/01
		, ,		11:08
1 -	1502	endpoint adj1 detect\$	USPAT;	2003/10/01
			EPO; JPO;	11:55
		·	DERWENT;	
			IBM TDB	
11	1	("5096550").PN.	USPAT	2003/10/01
				11:54
12	1	("5081796").PN.	USPAT	2003/10/01
		·		11:54
13	34	(endpoint adj1 detect\$) and electrolyte	USPAT;	2003/10/01
			EPO; JPO;	11:56
			DERWENT;	
			IBM_TDB	
14	11	((endpoint adj1 detect\$) and electrolyte)	USPAT;	2003/10/01
		and pad	EPO; JPO;	12:28
			DERWENT;	
1.5	_ [		IBM_TDB	0000/10/55
15	3	electrochemical adj1 mechanical adj1	USPAT	2003/10/01
1.6		polishing		12:29
16	35	(electrochemical adj1 mechanical adj1	USPAT	2003/10/01
17	1001	polishing) or ecmp		12:34
17	1024	204/224m	USPAT	2003/10/01
1.0		204/224		12:48
18	48	204/224m and pad	USPAT	2003/10/01
			<u> </u>	12:48